SLLS178D - APRIL 1994 - REVISED FEBRUARY 2000

● Single-Chip and Single-Supply Interface for IBM PC/AT [™] Serial Port	DB PACKAGE [†] (TOP VIEW)
 Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.11 Standards 	V _{DD} $\begin{bmatrix} 1 & 28 \end{bmatrix}$ C3+ C2+ $\begin{bmatrix} 2 & 27 \end{bmatrix}$ GND
 Operates With 3.3-V or 5-V Supplies 	V_{CC} [3 26] C3-
One Receiver Remains Active During	C2- [] 4 25 [] V _{SS}
Standby (Wake-up Mode)	EN 5 24 C1-
Designed to Operate at 128 kbit/s Over a	C1+ 6 23 STBY
3-m Cable	
Low Standby Current 5 μA Max	DIN2 [8 21] DOUT2 DIN3 [9 20] DOUT3
 ESD Protection on RS-232 Pins Meets or 	ROUT1 10 19 RIN1
Exceeds 4 kV (HBM) and 1.5 kV (HBM) on	ROUT2 11 18 RIN2
All Pins Per MIL-STD-883, Method 3015	ROUT3 🛛 12 17 🗍 RIN3
 External Capacitors 0.1 μF (V_{CC} = 3.3 V Five External Capacitors) 	ROUT4 🛛 13 16 🛛 RIN4
$(V_{CC} = 5.5 \text{ V} \dots \text{Four External Capacitors})$	ROUT5 14 15 RIN5
Accepts 5-V Logic Input With 3.3-V Supply	[†] The DB package is only
Applications	available in left-ended tape and
- RS-232 Interface	reel (order part number SN75LV4737ADBR).
 Battery-Powered Systems, PDAs 	/

- Notebook, Laptop, and Palmtop PCs
- External Modems and Hand-Held Terminals
- Packaged in Shrink Small-Outline Package

description

The SN75LV4737A[‡] consists of three line drivers, five line receivers, and a charge-pump circuit. It provides the electrical interface between an asynchronous communication controller and the serial-port connector, and meets the requirements of TIA/EIA-232-F. This combination of drivers and receivers matches those needed for the typical serial port used in an IBM PC/AT or compatibles. The charge pump and five small external capacitors allow operation from a single 3.3-V supply, and four capacitors allow operation from a 5-V supply.

The device has flexible control options for power management when the serial port is inactive. A common disable for all of the drivers and receivers is provided with the active-high STBY input. The active-low \overline{EN} input is an enable for one receiver to implement a wake-up feature for the serial port. All the logic inputs can accept signals from controllers operating from a 5-V supply, even though the SN75LV4737A is operating from 3.3 V.

The SN75LV4737A is characterized for operation over the temperature range of 0°C to 70°C.



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Function Tables

FACH	DRIVER
LAOII	

INP	UTS	OUTPUT					
DIN	STBY	DOUT					
Х	Н	Z					
L	L	н					
н	L	L					
Open	L	L					
H = high level, L = low level,							

X = irrelevant, Z = high impedance

EACH RECEIVER

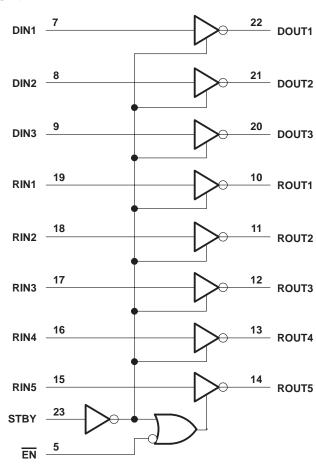
		INPUTS	OUTPUTS				
STBY	EN	RIN5	RIN1-RIN4	ROUT5	ROUT1-ROUT4		
Н	Н	Х	Х	Z	Z		
н	L	Н	Х	L	Z		
н	L	L	х	н	Z		
L	Х	L	L	н	Н		
L	Х	Н	Н	L	L		

H = high level, L = low level, X = irrelevant, Z = high impedance



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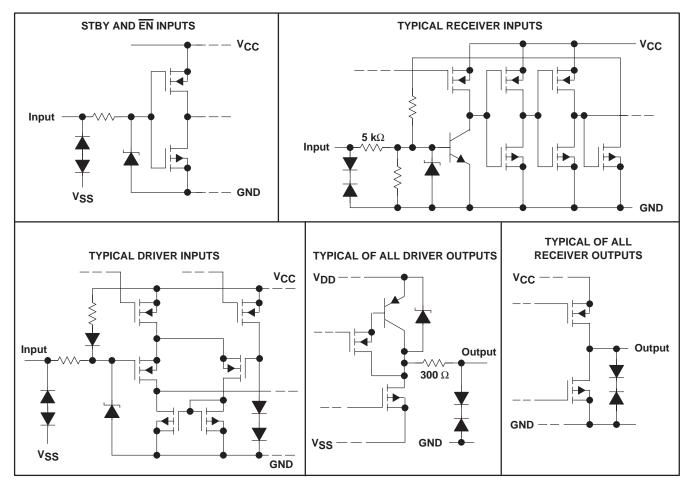
logic diagram (positive logic)





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schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Positive output supply voltage, V _{DD} (see Note 1)	15 V
Negative output supply voltage, V _{SS}	–15 V
Input voltage range, V _I : Driver	–3 V to 7 V
Receiver	
Output voltage range, V _O : Driver	
Receiver	–0.3 V to 7 V
Package thermal impedance, θ_{JA} (see Note 2)	
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltages are with respect to network GND.

2. The package thermal impedance is calculated in accordance with JESD 51.



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recommended operating conditions

				MIN	NOM	MAX	UNIT
Vaa	VCC Supply voltage		V _{CC} = 3.3 V	3	3.3	3.6	V
vCC			$V_{CC} = 5 V$	4.5	5	5.5	V
	Driver high-level input voltage	DIN, EN, STBY	V _{CC} = 3.3 V	2			
VIH		DIN		2			V
- 11 1		EN, STBY	V _{CC} = 5 V	2.5			
VIL	Driver low-level input voltage	DIN, EN, STBY	DIN, EN, STBY			0.8	V
VI	Receiver input voltage					±30	V
	External capacitor	3.3-V operation (C1, C2, C3, C4, C5), 5-V operation (C1, C3, C4, C5), See Note 3 and Figures 6 and 7		0.1			μF
TA	Operating free-air temperature	•		0		70	°C

NOTE 3: C2 is needed only for 3.3-V operation.

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (see Figures 6 and 7) (unless otherwise noted)

PARAMETER TEST CONDITIONS		CONDITIONS	V _{CC} = 3.3 V		V _{CC} = 5 V			UNIT		
	FARAIVIETER				TYP†	MAX	MIN	TYP†	MAX	UNIT
VDD	Positive supply voltage	No load	No load		10		7	8.7		V
VSS	Negative supply voltage	No load			-9.5	-7		-8	-6	V
Ц	Input current (EN, STBY)	See Notes 4 and 5				±2			±2	μΑ
	Supply current		STBY at GND, EN at V _{CC} or GND	8.4	10	18	10	12	20.7	mA
ICC	Supply current (standby mode) (see Note 4)	No load, Inputs open	$\overline{\text{EN}}$, STBY at V _{CC}			5			5	۵
	Supply current (wake-up mode) (see Note 5)		EN at GND, STBY at V _{CC}			10			10	μA

[†] All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.

NOTES: 4. When standby mode is not used, STBY input must be taken low.

5. When wake-up mode is not used, EN input must be taken high.



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DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			TYP†	MAX	UNIT
Vон	High-level output voltage	$R_L = 3 k\Omega$		5.5	7		V
VOL	Low-level output voltage	$R_L = 3 k\Omega$			-6	-5	V
Ιн	High-level input current	$A^{I} = A^{CC}$				1	μΑ
۱ _{IL}	Low-level input current	V _I at GND				-10	μΑ
100	Short-circuit output current (see Note 6)	V _{CC} = 3.6 V,	VO = 0 V		±15	+40	mA
los	Shon-circuit output current (see Note 6)	V _{CC} = 5.5 V,	VO = 0 V		±15	±40	ША
r _o	Output resistance	$V_{CC} = V_{DD} = V_{SS} = 0 V,$	$V_{O} = \pm 2 V$	300	500		Ω

[†] All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.

NOTE 6: Short-circuit durations should be controlled to prevent exceeding the device absolute maximum power dissipation ratings, and not more than one output should be shorted at a time.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER TEST CONDITIONS			NDITIONS	MIN	TYP [†]	MAX	UNIT
	Propagation delay time, low- to high-level output		V _{CC} = 3.3 V	100	500	850	ns
^t PLH	Propagation delay time, low- to high-level output	$C_{L} = 50 \text{ pF},$	$V_{CC} = 5 V$	100	500	850	115
to	Propagation delay time, high- to low-level output	$R_L = 3 k\Omega$ to 7 k Ω , See Figure 1	V _{CC} = 3.3 V	100	500	850	ns
^t PHL	Propagation delay time, high- to low-level output	Ũ	$V_{CC} = 5 V$	100	500	850	115
^t PZH	Output enable time to high level	C _L = 50 pF,	$R_L = 3 k\Omega$ to 7 k Ω ,		1	5	ms
^t PZL	Output enable time to low level	See Figure 2			3	7	ms
10.17	Output disable time from high level		V _{CC} = 3.3 V		0.9	3	
^t PHZ		$C_L = 50 \text{ pF},$ $R_L = 3 \Omega \text{ to } 7 \Omega,$	$V_{CC} = 5 V$		0.6	3	μs
to: 7	Output disable time from low level	See Figure 2	V _{CC} = 3.3 V		0.5	3	
^t PLZ	Output disable time norm low level	Ű	$V_{CC} = 5 V$		0.3	3	μs
SR	Slew rate	C _L = 50 pF, See Figure 1	$R_L = 3 k\Omega$ to 7 k Ω ,	4		30	V/µs
SR(tr)	Slew rate, transition region	C _L = 2500 pF, See Figure 3	$R_L = 3 \text{ k}\Omega \text{ to } 7 \text{ k}\Omega$,	3		30	V/µs

[†] All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.



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RECEIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CONDITIONS			TYP†	MAX	UNIT
VOH	High-level output voltage		V _{CC} = 3.3 V	2.4	3		V
		$I_{OH} = -2 \text{ mA}$	$V_{CC} = 5 V$	3.5	5		v
VOL	Low-level output voltage	$I_{OL} = 2 \text{ mA}$		0.2	0.4	V	
VIT+	Positive-going input threshold voltage				2.2	2.6	V
V _{IT}	Negative-going input threshold voltage			0.6	1		V
V _{hys}	Input hysteresis (V _{IT+} – V _{IT} _)			0.5	1.2	1.8	V
ri	Input resistance	$V_{I} = \pm 3 V \text{ to } \pm 25 V$		3	5	7	kΩ

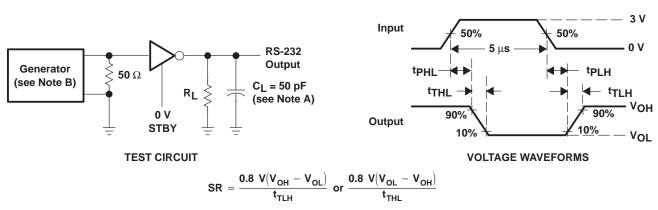
[†] All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF, R_L = 3 k Ω to GND

DADAMETED		PARAMETER TEST V _{CC} = 3.3 V		V	UNIT				
	PARAMETER		MIN	TYP	MAX	MIN	TYP	MAX	UNIT
^t PLH	Propagation delay time, low- to high-level output		10	70	200	10	70	200	ns
^t PHL	Propagation delay time, high- to low-level output]	10	60	200	10	55	200	ns
^t PLH	Propagation delay time, low- to high-level output (wake-up mode)	See Figure 4		40	200		40	200	μs
^t PHL	Propagation delay time, high- to low-level output (wake-up mode)			90	500		70	500	ns
^t PZH	Output enable time to high level			3	10		1.2	10	μs
^t PZL	Output enable time to low level	Soo Eiguro E		100	250		60	250	ns
^t PHZ	Output disable time from high level	See Figure 5	100	200	600	100	150	600	ns
^t PLZ	Output disable time from low level			130	250		60	250	ns



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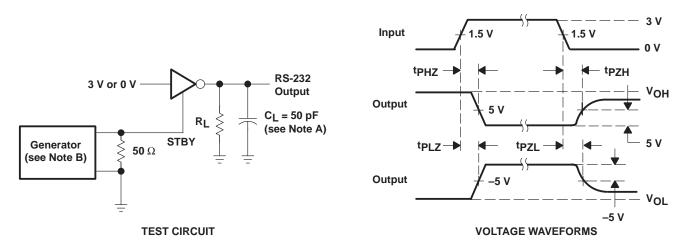


PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. The pulse generator has the following characteristics: $Z_0 = 50 \Omega$, 50% duty cycle, $t_f \le 10$ ns. $t_f \le 10$ ns.

Figure 1. Driver Propagation Delay Times and Slew Rate (5-µs Input)



NOTES: A. C_L includes probe and jig capacitance.

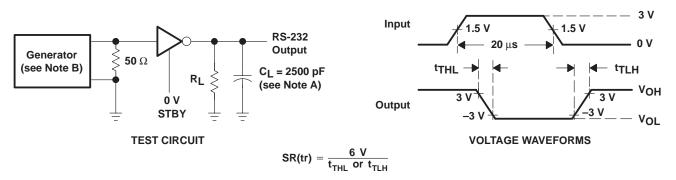
B. The pulse generator has the following characteristics: $Z_O = 50 \Omega$, 50% duty cycle, $t_f \le 10$ ns. $t_f \le 10$ ns.

Figure 2. Driver Enable and Disable Test Times



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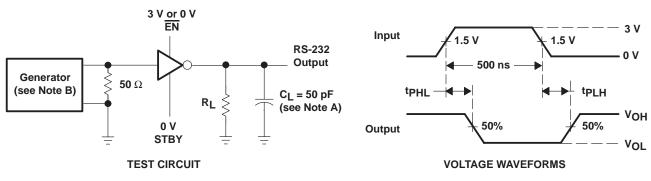
PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

B. The pulse generator has the following characteristics: $Z_O = 50 \Omega$, 50% duty cycle, $t_f \le 10$ ns. $t_f \le 10$ ns.

Figure 3. Driver Transition Times and Slew Rate (20-µs Input)

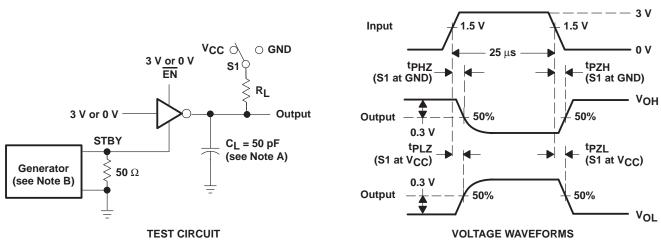


NOTES: A. C_L includes probe and jig capacitance. B. The pulse generator has the following characteristics: PRR = 1 MHz, $Z_O = 50 \Omega$, 50% duty cycle, $t_f \le 10$ ns. $t_f \le 10$ ns.

Figure 4. Receiver Propagation Delay Times



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PARAMETER MEASUREMENT INFORMATION

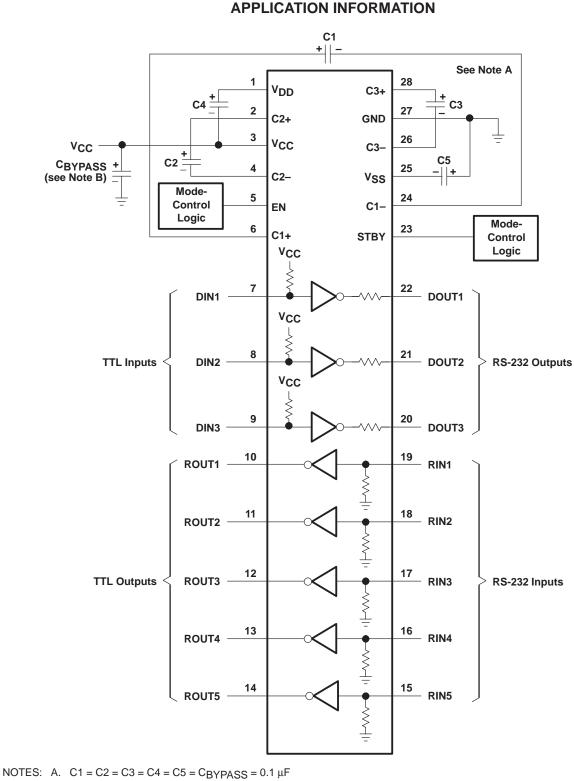
NOTES: A. CL includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 1 MHz, $Z_O = 50 \Omega$, 50% duty cycle, $t_f \le 10$ ns. $t_f \le 10$ ns.

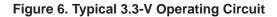
Figure 5. Receiver Enable and Disable Times



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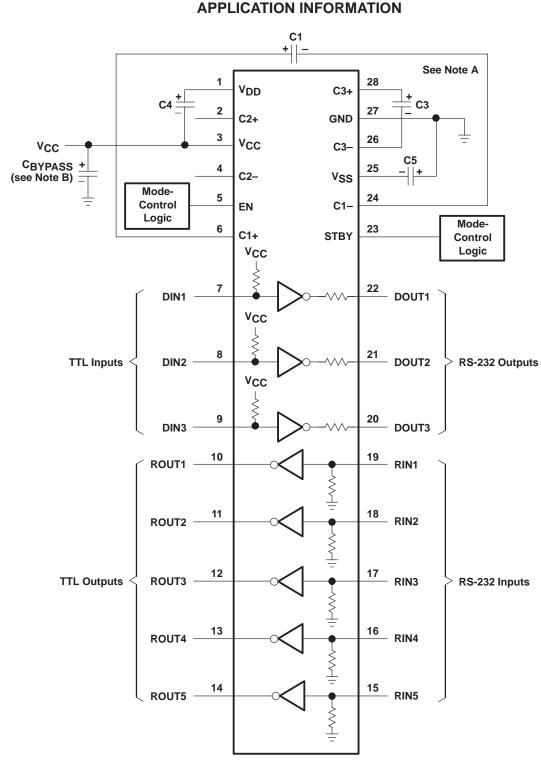


B. CBYPASS is used as a decoupling capacitor.



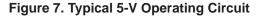


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NOTES: A. C2 is not used. C1 = C3 = C4 = C5 = C_{BYPASS} = 0.1 μ F

B. C_{BYPASS} is used as a decoupling capacitor.





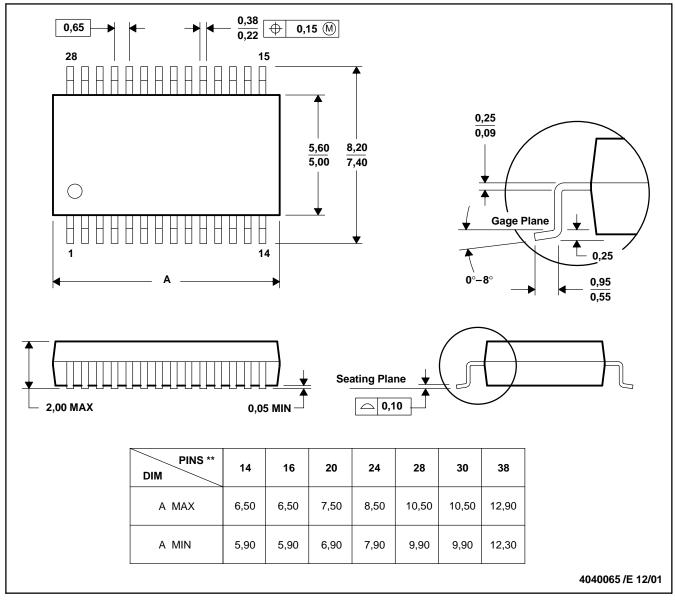
MECHANICAL DATA

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



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